PROFITAP

PT-25G-SR-85

DATASHEET

1. PRODUCT FEATURES

- Hot-pluggable SFP28 form factor
- Supports 25Gbps data rate
- Maximum link length of 70m on OM3 MMF and 100m on OM4 MMF
- 850nm VCSEL laser and PIN photo-detector
- Internal CDR on both Transmitter and Receiver channel
- Duplex LC receptacle
- Single 3.3V power supply
- Power dissipation < 1W
- Digital diagnostics functions are available via the I2C interface
- RoHS-6 compliant
- Commercial case temperature range:
  Standard : 0 to +70°C
  Industrial : -40 to +85°C

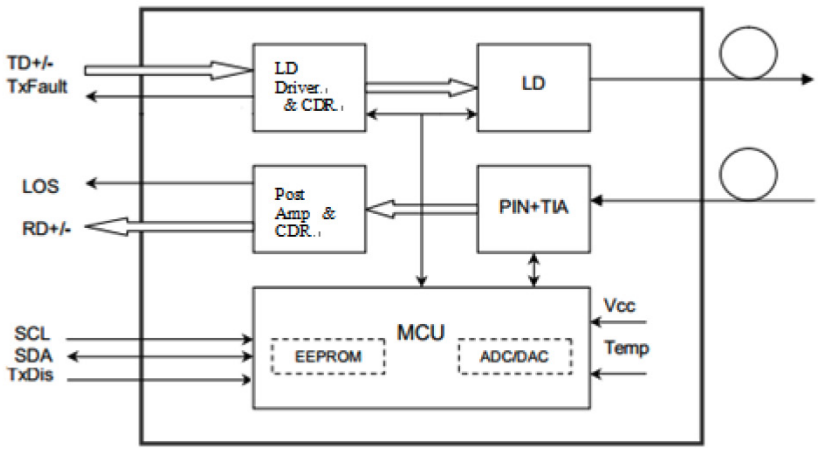
2. GENERAL DESCRIPTION

Profitap PT-25G-SR-85 is a single-Channel, Pluggable, Fiber-Optic SFP28 for 25 Gigabit Ethernet and Infiniband EDR Applications. It is a high performance module for short-range data communication and interconnect applications which operate at 25.78125 Gbps up to 70 m using OM3 fiber or 100 m using OM4 fiber. This module is designed to operate over multimode fiber systems using a nominal wavelength of 850nm. The electrical interface uses a 20 contact edge type connector. The optical interface uses duplex LC receptacle. This module incorporates Profitap proven circuit and VCSEL technology to provide reliable long life, high performance, and consistent service.

APPLICATIONS

- 25GBASE-SR Ethernet

3. BLOCK DIAGRAM



4. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage	VCC	0	3.6	°C	
Storage Temperature	Ts	-40	+85	°C	
Operating Humidity	-	5	85	%	

5. RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature Commercial	Tc	0		+70	°C
Power Supply Voltage	VCC	3.13	3.3	3.47	V
Power Supply Current	Icc			300	mA
Fiber Length on 50/125μm high-bandwidth (OM3) MMF				70	m
Fiber Length on 50/125μm high-bandwidth (OM4) MMF				100	m

6. OPTICAL AND ELECTRICAL CHARACTERISTICS

TRANSMITTER

Parameter		Symbol	Min	Typical	Max	Unit	Notes
Data rate		BR		25.78		Gbps	
Centre Wavelength		λc	840	850	860	nm	
Spectral Width (-20dB)		σ			0.6	nm	
Average Output Power		Pavg	-8.4		2.4	dBm	
Optical Power OMA		POMA	-6.4		3	dBm	
Extinction Ratio		ER	2			dB	
Differential data input swing		VIN,PP	40		1000	mV	
Input Differential Impedance		ZIN	90	100	110	Ω	
TX Disable	Disable		2.0		Vcc	V	
	Enable		0		0.8	V	
TX Fault	Fault		2.0		Vcc	V	
	Normal		0		0.8	V	

RECEIVER

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Data rate	BR		25.78		Gbps	
Centre Wavelength	λc	840	850	860	nm	
Receiver Sensitivity (OMA)	Psens	-	-	-10	dBm	
Stressed Sensitivity (OMA)		-	-	-5.2	dBm	
Receiver Power (OMA)				3	dBm	
LOS De-Assert	LOSD	2		-13	dBm	
LOS Assert	LOSA	-30			dBm	
LOS Hysteresis		0.5			dB	
Differential data output swing	Vout,PP	500		1130	mV	
LOS	High	2.0		Vcc	V	
	Low			0.8	V	

7. TIMING AND ELECTRICAL

Parameter	*Symbol*	*Min.*	*Max.*	*Unit*	*Conditions*
Tx_Disable assert time	t_off		100	µs	Rising edge of Tx_Disable to fall of output signal below 10% of nominal
Tx_Disable negate time	t_on		2	ms	Falling edge of Tx_Disable to rise of output signal above 90% of nominal. This only applies in normal operation, not during start up or fault recovery.
Time to initialize 2-wire interface	t_2w_start_up		300	ms	From power on or hot plug after the supply meeting Table 8.
Time to initialize	t_start_up		300	ms	From power supplies meeting Table 8 or hot plug or Tx disable negated during power up, or Tx_Fault recovery, until non-cooled power level I part (or non-cooled power level II part already enabled at power level II for Tx_Fault recovery) is fully operational.
Time to initialize cooled module and time to power up a cooled module to Power Level II	t_start_up_cooled		90	s	From power supplies meeting Table 8 or hot plug, or Tx disable negated during power up or Tx_Fault recovery, until cooled power level I part (or cooled power level II part during fault recovery) is fully operational. Also, from stop bit low-to-high SDA transition enabling Power Level II until cooled module is fully operational
Time to Power Up to Level II	t_power_level2		300	ms	From stop bit low-to-high SDA transition enabling power level II until non-cooled module is fully operational
Time to Power Down from Level II	t_power_down		300	ms	From stop bit low-to-high SDA transition disabling power level II until module is within power level I requirements
Tx_Fault assert	Tx_Fault_on		1	ms	From occurrence of fault to assertion of Tx_Fault
Tx_Fault assert for cooled module	Tx_Fault_on_cooled		50	ms	From occurrence of fault to assertion of Tx_Fault
Tx_Fault Reset	t_reset	10		µs	Time Tx_Disable must be held high to reset Tx_Fault
RS0, RS1 rate select timing for FC	t_RS0_FC, t_RS1_FC		500	µs	From assertion till stable output
RS0, RS1 rate select timing non FC	t_RS0, t_RS1		24	ms	From assertion till stable output
Rx_LOS assert delay	t_los_on		100	µs	From occurrence of loss of signal to assertion of Rx_LOS
Rx_LOS negate delay	t_los_off		100	µs	From occurrence of presence of signal to negation of Rx_LOS

8. DIAGNOSTICS SPECIFICATION

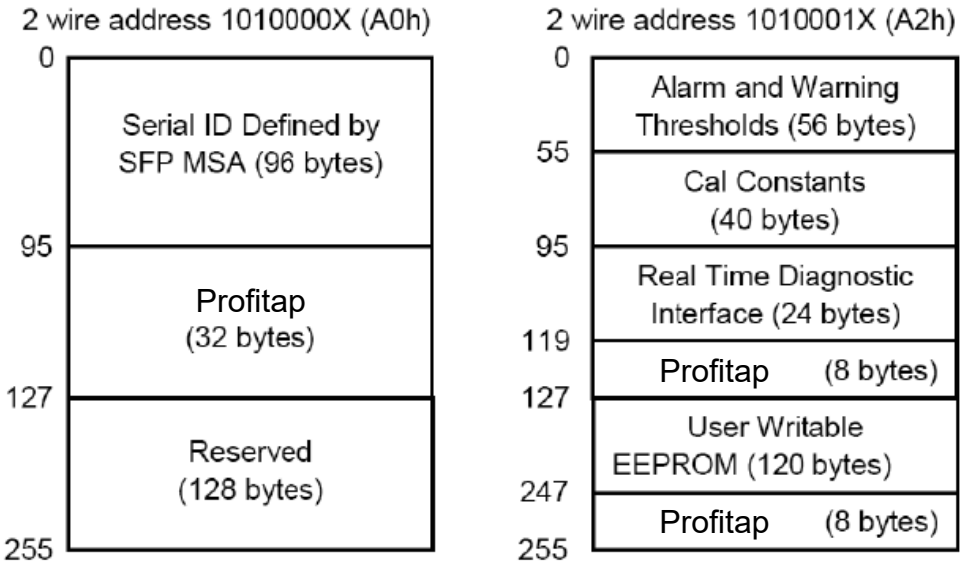
Parameter	Range	Unit	Accuracy	Calibration
Temperature	0 to +70	°C	±3°C	Internal / External
Voltage	3.0 to 3.6	V	±3%	Internal / External
Bias Current	0 to 20	mA	±10%	Internal / External
TX Power	-8 to 3	dBm	±3dB	Internal / External
RX Power	-14 to 0	dBm	±3dB	Internal / External

10. DIGITAL DIAGNOSTIC MEMORY MAP

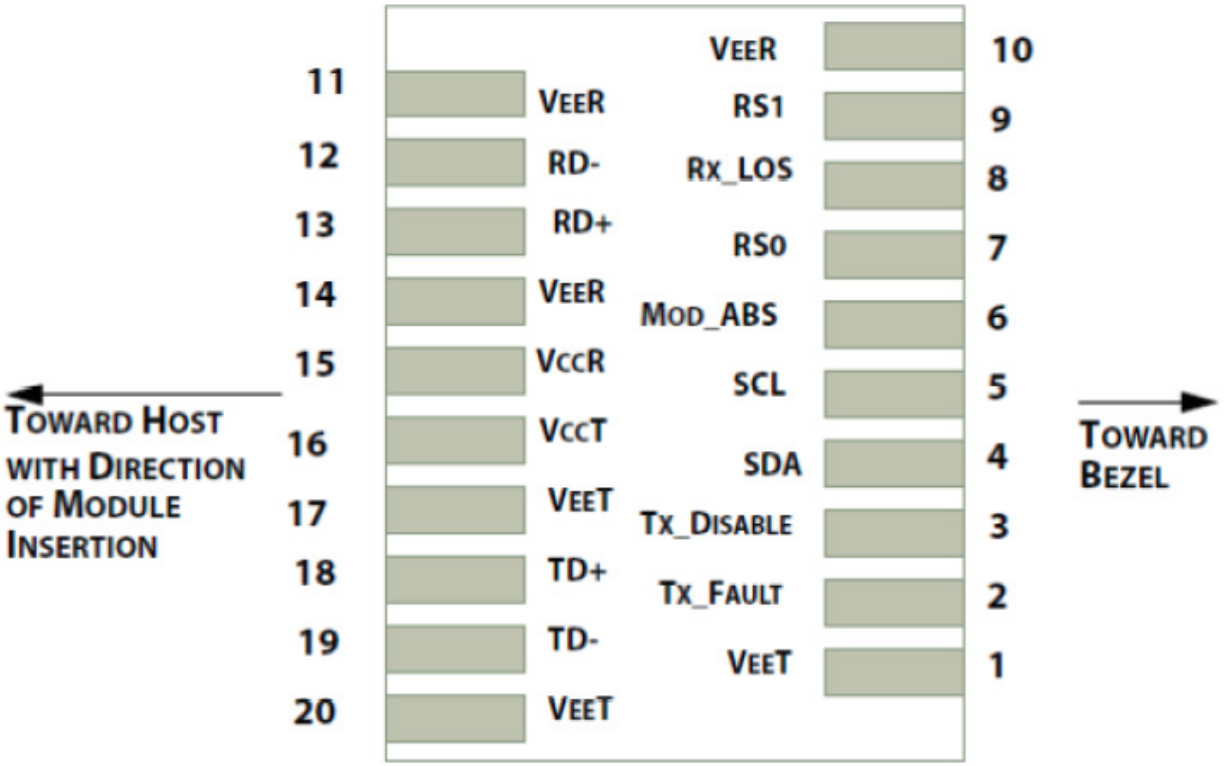
The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

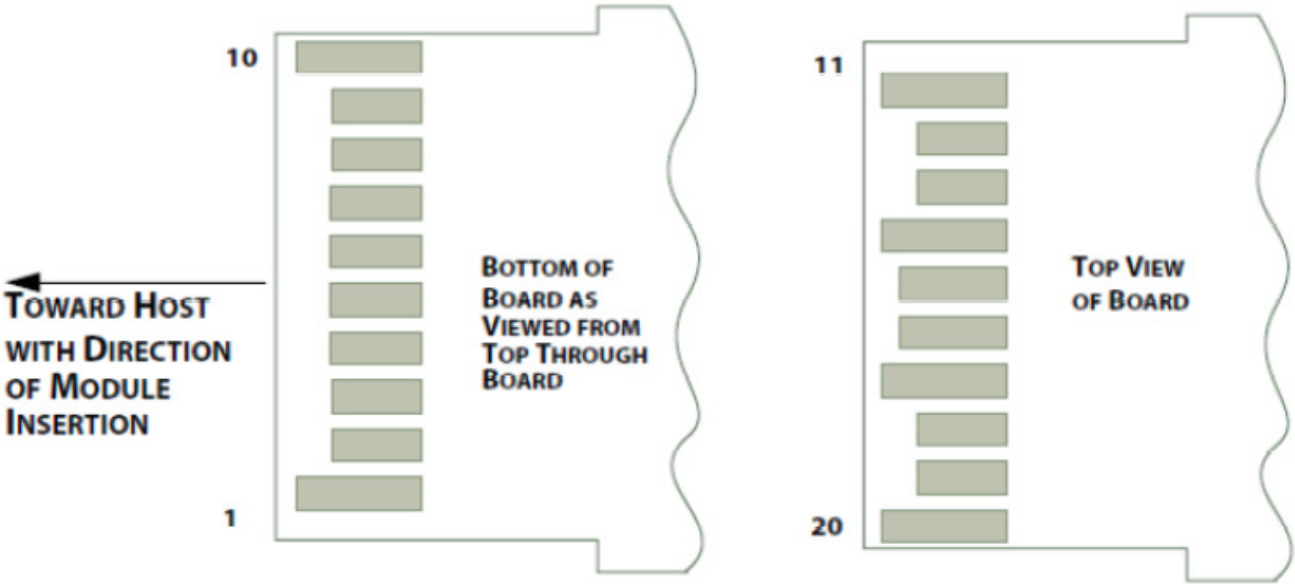
The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.



11. PIN DEFINITIONS





12. PIN DESCRIPTIONS

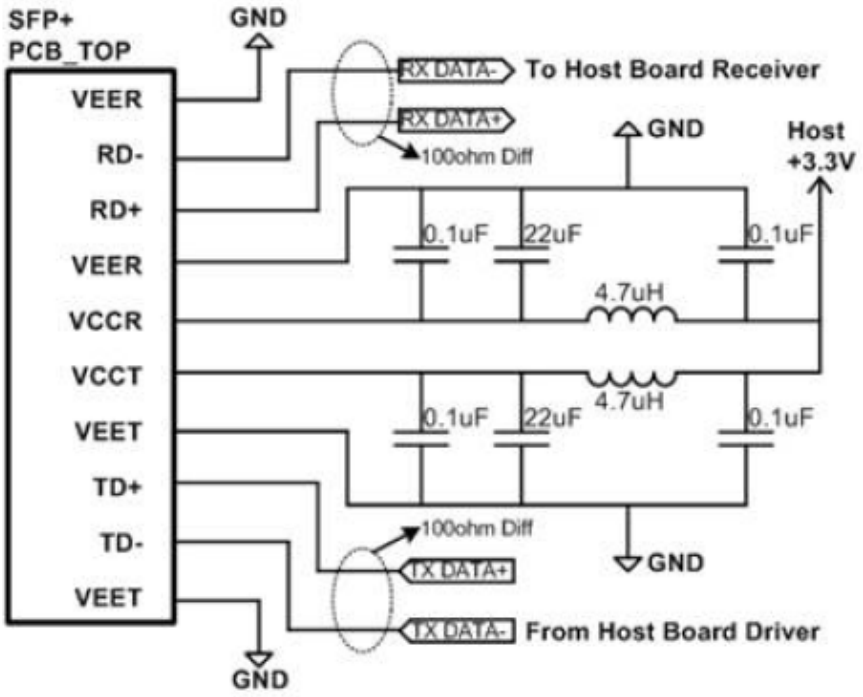
PIN	Logic	Symbol	Name / Description	Note
1		VeeT	Module Transmitter Ground	1
2	LVTTL-O	TX_Fault	Module Transmitter Fault	2
3	LVTTL-I	TX_Dis	Transmitter Disable; Turns off transmitter laser output	
4	LVTTL-I/O	SDA	2-Wire Serial Interface Data Line	2
5	LVTTL-I	SCL	2-Wire Serial Interface Clock	2
6		MOD_ABS	Module Definition, Grounded in the module	
7	LVTTL-I	RS0	Receiver Rate Select	
8	LVTTL-O	RX_LOS	Receiver Loss of Signal Indication Active LOW	
9	LVTTL-I	RS1	Transmitter Rate Select (not used)	
10		VeeR	Module Receiver Ground	1
11		VeeR	Module Receiver Ground	1
12	CML-O	RD-	Receiver Inverted Data Output	
13	CML-O	RD+	Receiver Data Output	
14		VeeR	Module Receiver Ground	1
15		VccR	Module Receiver 3.3 V Supply	
16		VccT	Module Receiver 3.3 V Supply	
17		VeeT	Module Transmitter Ground	1
18	CML-I	TD+	Transmitter Non-Inverted Data Input	
19	CML-I	TD-	Transmitter Inverted Data Input	
20		VeeT	Module Transmitter Ground	1

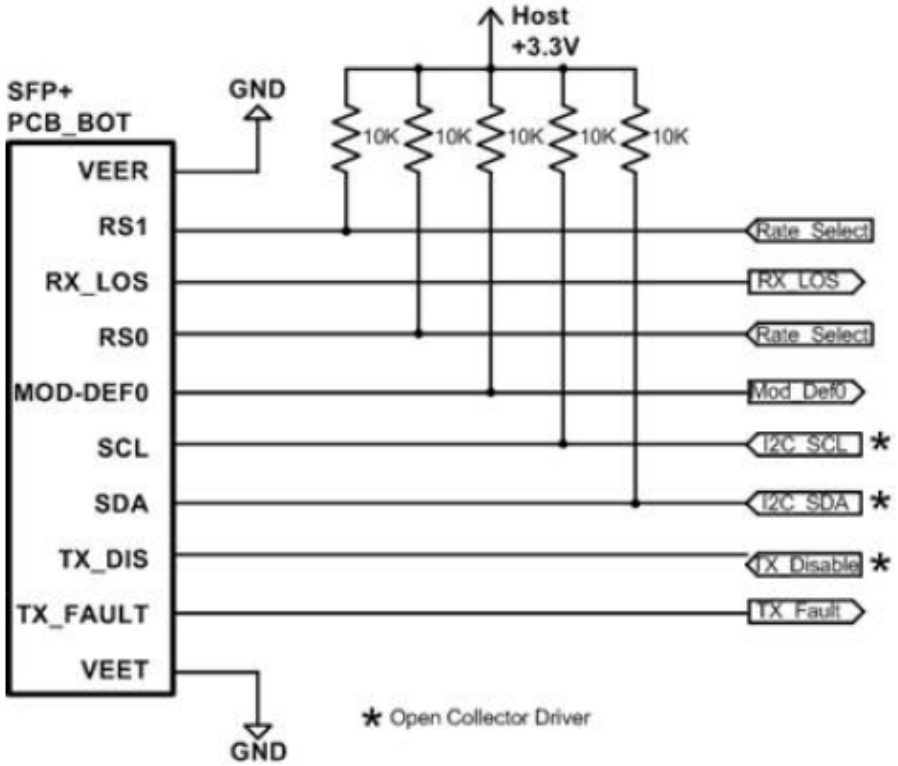
NOTE

1. Module ground pins GND are isolated from the module case.

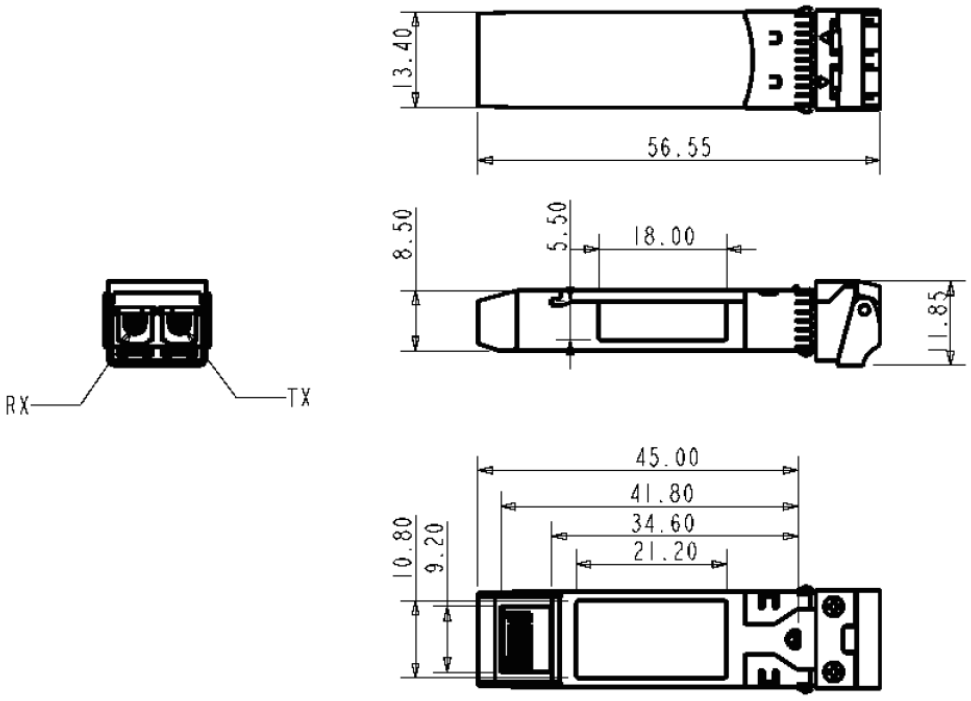
2. Shall be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.45V on the host board.

13. RECOMMENDED INTERFACE CIRCUIT





14. MECHANICAL DIMENSIONS



14. REGULATORY COMPLIANCE

Feature	Agency	Standard
Laser Safety	FDA	CDRH 21 CFR 1040 annd Laser Notice No. 50
Product Safety	BST	EN 60825-1: 2007 EN 60825-2: 2004 EN 60950-1: 2006
Environmental protection	SGS	RoHS Directive 2002/95/EC
EMC	CCIC	EN 55022: 2006+A1: 2007 EN 55024: 1998+A1: 2001+A2: 2003

15. ORDERING INFORMATION

Part Number	Product Description
PT-25G-SR-85	25G SFP28 850NM 100M

16. IMPORTANT NOTICE

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